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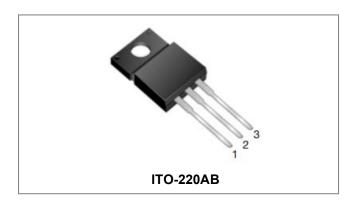


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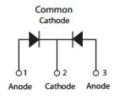
### **MBRF2080CTL SCHOTTKY RECTIFIER**



#### **Features**

- 150°C T<sub>J</sub> operation
- Center tap configuration
- · Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

### **Circuit Diagram**



#### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

### **Maximum Ratings:**

| Characteristics  | Symbol   | Condition                                       | Max.                          | Units |
|--|--|---|-------------------------------|-------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | -   | 80                            | V     |
| Average Rectified Forward Current  | I <sub>F (AV)</sub>                                    | 50% duty cycle @Tc=100°C, rectangular wave form | 10(Per Leg)<br>20(Per Device) | Α     |
| Peak One Cycle Non-Repetitive<br>Surge Current(Per Leg)                                | I <sub>FSM</sub>                                       | 8.3ms, Half Sine pulse                          | 150                           | А     |

#### **Electrical Characteristics:**

| Characteristics  | Symbol   | Condition   | Тур. | Max.   | Units |
|--|----------|---|------|--------|-------|
| Forward Voltage Drop(Per Leg)*   | $V_{F1}$ | V <sub>F1</sub> @10A, Pulse, T <sub>J</sub> = 25 °C   |      | 0.75   | V     |
| Reverse Current(Per Leg)* I <sub>R1</sub>                                    |          | @V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 25 °C   | 0.05 | 1.0    | mA    |
|  | $I_{R2}$ | $@V_R = \text{rated } V_{R_i} T_J = 125  ^{\circ}\text{C}$  | 28   | 50     | mA    |
| Junction Capacitance(Per Leg)  | Ст       | $@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$  | 180  | 500    | pF    |
| Series Inductance(Per Leg)   | Ls       | Measured lead to lead 5 mm from package body  | 8.0  | -      | nH    |
| Voltage Rate of Change   | dv/dt    | -   | -    | 10,000 | V/μs  |
| RSM Isolation Voltage $(t = 1.0 \text{ second}, R. H. < =30\%, T_A = 25 °C)$ |          | Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction. | -    | 4500   | V     |
| ·  |          | Clip mounting, the epoxy body is inside the heatsink.   | -    | 3500   |       |
|  |          | Screw mounting, the epoxy body is inside the heatsink.  | -    | 1500   |       |

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

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### **Thermal-Mechanical Specifications:**

| Characteristics                             | Symbol            | Condition    | Specification | Units |
|---|-------------------|--------------|---------------|-------|
| Junction Temperature                        | TJ                | -            | -55 to +150   | °C    |
| Storage Temperature                         | T <sub>stg</sub>  | -            | -55 to +150   | °C    |
| Typical Thermal Resistance Junction to Case | R <sub>0</sub> JC | DC operation | 2.0           | °C/W  |
| Approximate Weight                          | wt                | -            | 2             | g     |
| Case Style                                  | ITO-220AB         |              |               |       |

### **Ratings and Characteristics Curves**

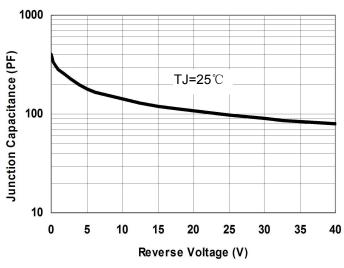


Fig.1-Typical Junction Capacitance

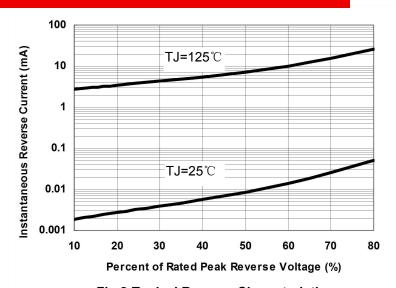


Fig.2-Typical Reverse Characteristics

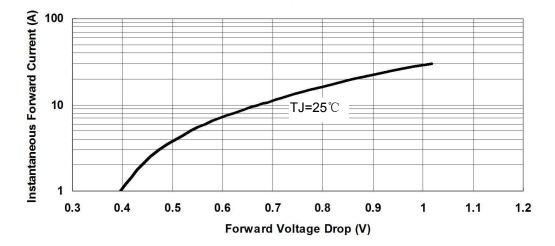


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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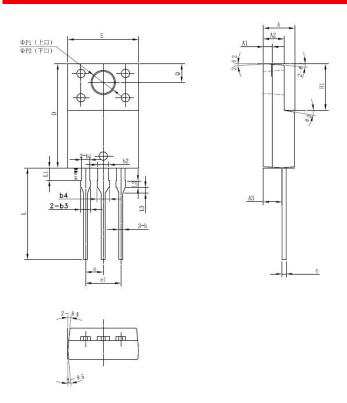


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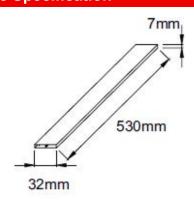


#### **Mechanical Dimensions ITO-220AB**



| OVMDOL          | Millimeters |       |       |  |  |
|-----------------|-------------|-------|-------|--|--|
| SYMBOL          | MIN.        | TYP.  | MAX.  |  |  |
| Α               | 4.30        | 4.50  | 4.70  |  |  |
| A1              | 1.10        | 1.30  | 1.50  |  |  |
| A2              | 2.80        | 3.00  | 3.20  |  |  |
| A3              | 2.50        | 2.70  | 2.90  |  |  |
| b               | 0.50        | 0.60  | 0.75  |  |  |
| b1              | 1.10        | 1.20  | 1.35  |  |  |
| b2              | 1.50        | 1.60  | 1.75  |  |  |
| b3              | 1.20        | 1.30  | 1.45  |  |  |
| b4              | 1.60        | 1.70  | 1.85  |  |  |
| С               | 0.50        | 0.60  | 0.75  |  |  |
| D               | 14.80       | 15.00 | 15.20 |  |  |
| E               | 9.96        | 10.16 | 10.36 |  |  |
| е               |             | 2.55  |       |  |  |
| e1              |             | 5.10  |       |  |  |
| H1              | 6.50        | 6.70  | 6.90  |  |  |
| L               | 12.70       | 13.20 | 13.70 |  |  |
| L1              | 1.60        | 1.80  | 2.00  |  |  |
| L2              | 0.80        | 1.00  | 1.20  |  |  |
| L3              | 0.60        | 0.80  | 1.00  |  |  |
| ФР1(上□)         | 3.30        | 3.50  | 3.70  |  |  |
| <b>ΦP2</b> (下口) | 2.99        | 3.19  | 3.39  |  |  |
| Q               | 2.50        | 2.70  | 2.90  |  |  |
| Θ1              |             | 5°    |       |  |  |
| Θ2              |             | 4°    |       |  |  |
| Θ3              |             | 10°   |       |  |  |
| Θ4              |             | 5°    |       |  |  |
| Θ5              |             | 5°    |       |  |  |

### **Tube Specification**



## **Marking Diagram**



Where XXXXX is YYWWL

 MBR
 = Device Type

 F
 = Package type

 20
 = Forward Current (20A)

 80
 = Reverse Voltage (80V)

 CTL
 = Configuration

 SSG
 = SSG

 YY
 = Year

WW = Week
L = Lot Number

**Cautions:** Molding resin Epoxy resin UL:94V-0

### **Ordering Information**

| Device      | Package                | Shipping     |
|-------------|------------------------|--------------|
| MBRF2080CTL | ITO-220AB<br>(Pb-Free) | 50 pcs/ tube |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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#### MBRF2080CTL



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